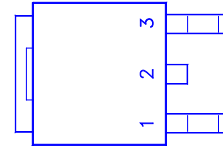
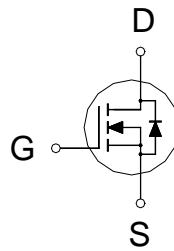




PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
60V	100mΩ	10A



- 1. GATE
- 2. DRAIN
- 3. SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current ²	$T_C = 25\text{ °C}$	I_D	10	A
	$T_C = 100\text{ °C}$		6	
Pulsed Drain Current ¹		I_{DM}	15	
Avalanche Current		I_{AS}	9.5	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	4.5	mJ
Power Dissipation	$T_C = 25\text{ °C}$	P_D	21	W
	$T_C = 100\text{ °C}$		8	
Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		5.8	°C / W
Junction-to-Ambient	$R_{\theta JA}$		62.5	

¹Pulse width limited by maximum junction temperature.

²Package limitation current is 5A

ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ °C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	60			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.3	1.8	2.3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 48V, V_{GS} = 0V$			1	μA
		$V_{DS} = 40V, V_{GS} = 0V, T_J = 125\text{ °C}$			10	
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 1A$		93	125	mΩ
		$V_{GS} = 10V, I_D = 1A$		77	100	

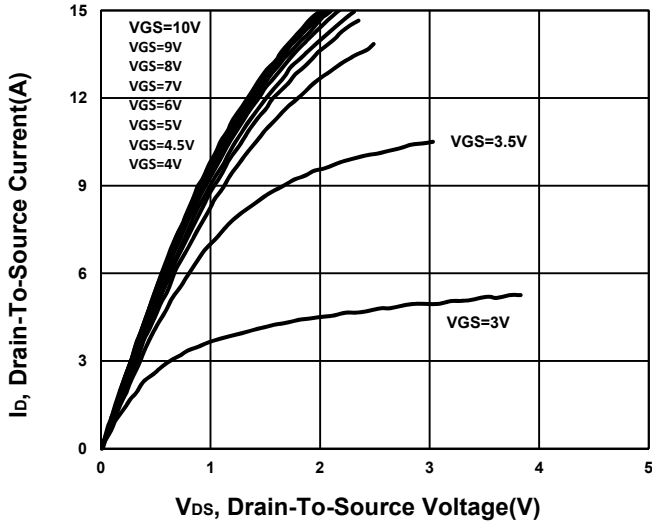
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 1A$		5		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		205		pF
Output Capacitance	C_{oss}			44		
Reverse Transfer Capacitance	C_{rss}			25		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		2		Ω
Total Gate Charge ²	$Q_{g(VGS=10V)}$	$V_{DS} = 30V, I_D = 1A$		6		nC
	$Q_{g(VGS=4.5V)}$			4		
Gate-Source Charge ²	Q_{gs}			0.6		
Gate-Drain Charge ²	Q_{gd}			2.2		
Turn-On Delay Time ²	$t_{d(on)}$		$V_{DS} = 30V$ $I_D \cong 1A, V_{GS} = 10V, R_{GEN} = 25\Omega$		20	
Rise Time ²	t_r			60		
Turn-Off Delay Time ²	$t_{d(off)}$			25		
Fall Time ²	t_f			40		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current ³	I_S			9		A
Forward Voltage ¹	V_{SD}	$I_F = 1A, V_{GS} = 0V$		1.2		V
Reverse Recovery Time	t_{rr}	$I_F = 1A, di_F/dt = 100A / \mu S$		14		nS
Reverse Recovery Charge	Q_{rr}			6		nC

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

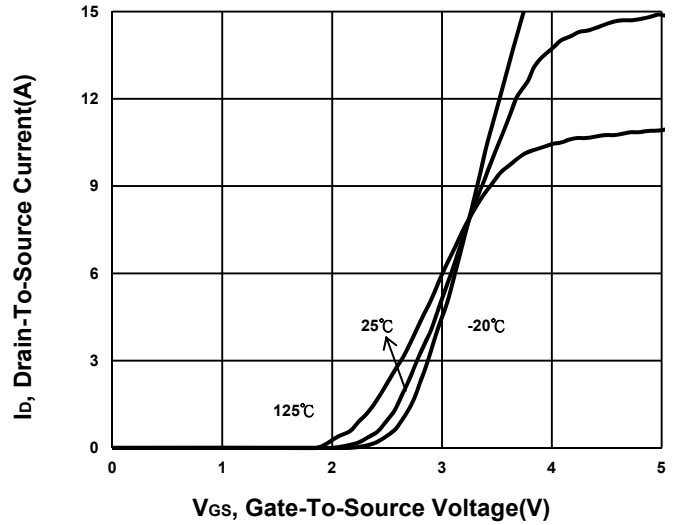
²Independent of operating temperature.

³Package limitation current is 5A

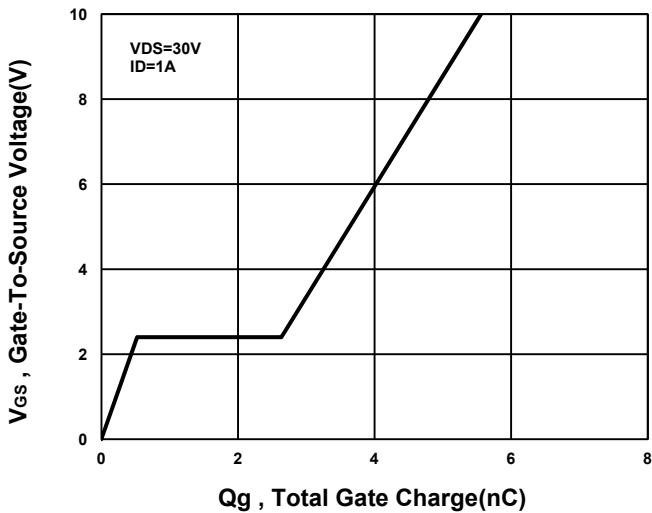
Output Characteristics



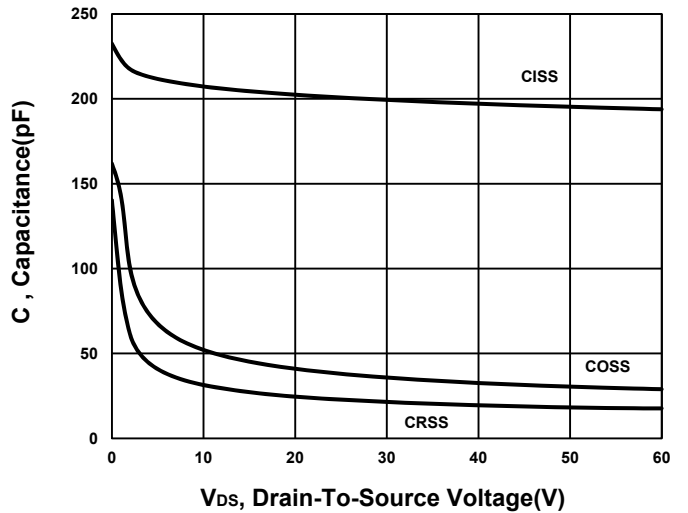
Transfer Characteristics



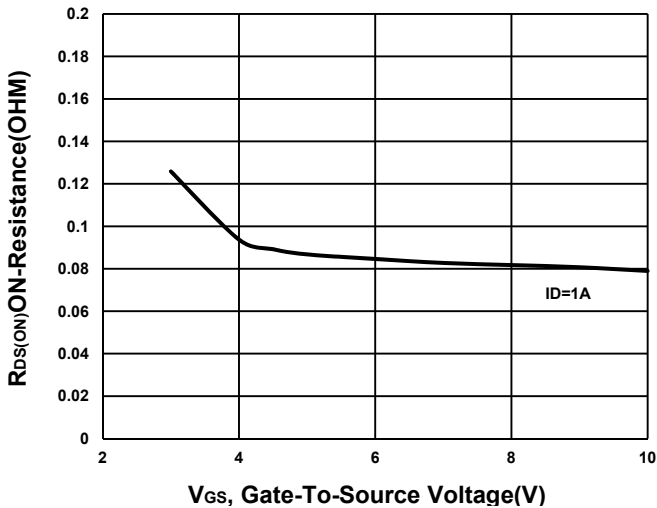
Gate charge Characteristics



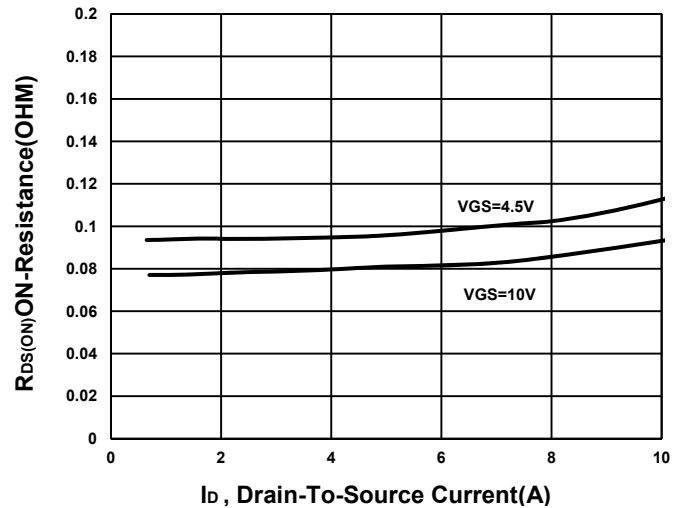
Capacitance Characteristic



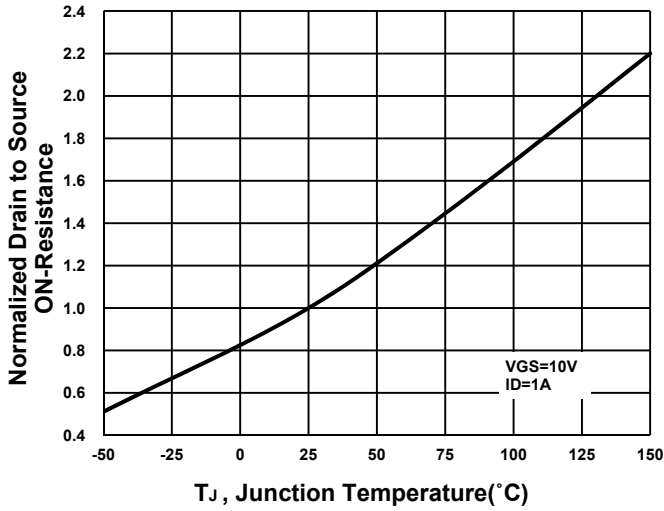
On-Resistance VS Gate-To-Source



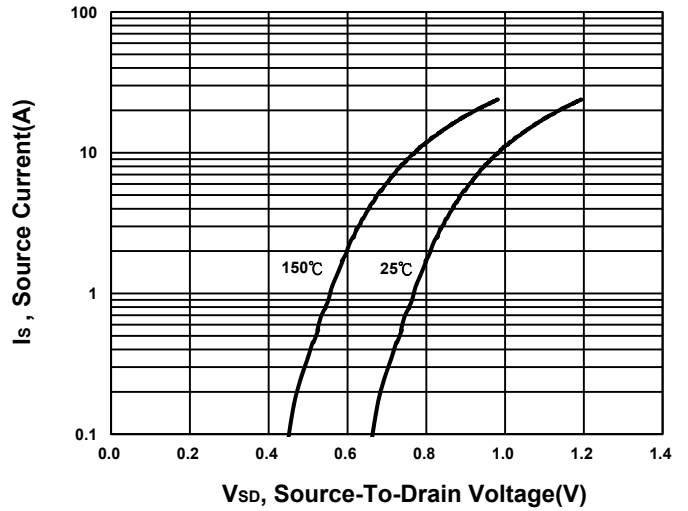
On-Resistance VS Drain Current



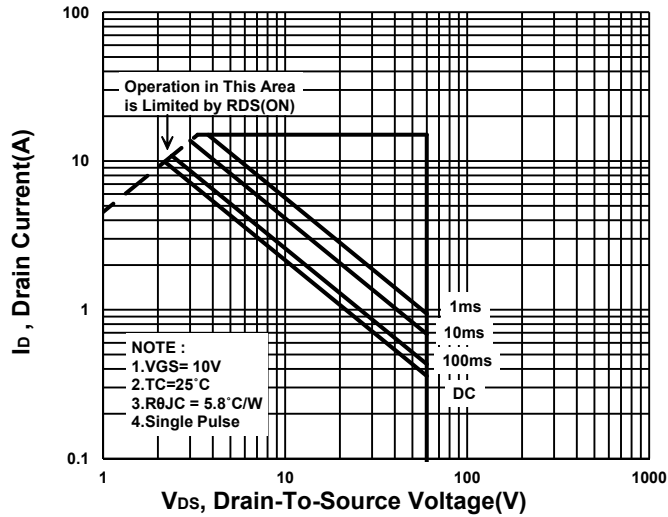
On-Resistance VS Temperature



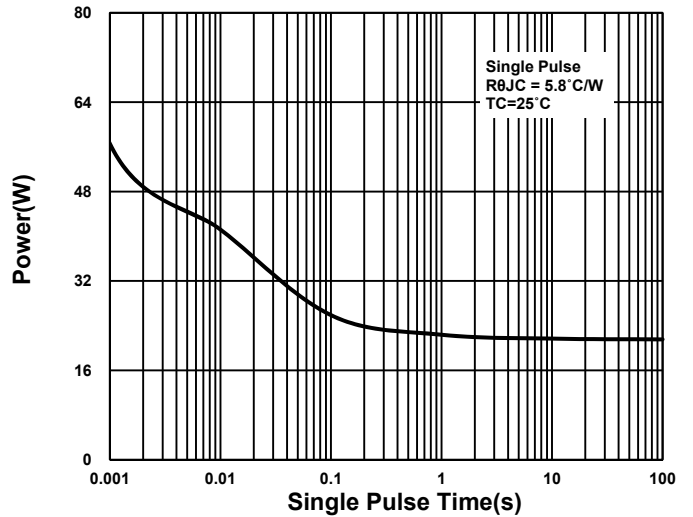
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

